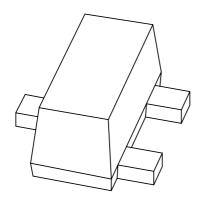
DISCRETE SEMICONDUCTORS

DATA SHEET



PDTC144TEF

NPN resistor-equipped transistor; R1 = 47 k Ω , R2 = open

Product specification

2002 Mar 15





NPN resistor-equipped transistor; R1 = 47 k Ω , R2 = open

PDTC144TEF

FEATURES

- Built-in bias resistors
- 250 mW total power dissipation
- Very small 1.6 × 0.85 mm thin package
- Flat leads
- · Excellent coplanarity
- Improved thermal behaviour
- Reduces number of components and required PCB area.

APPLICATIONS

- General purpose switching and amplification
- · Inverter and interface circuits
- · Driver circuits.

DESCRIPTION

NPN resistor equipped transistor in a SOT490 (SC-89) plastic package.

MARKING

TYPE NUMBER	MARKING CODE		
PDTC144TEF	33		

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
V _{CEO}	collector-emitter voltage	50	V
Io	output current (DC)	100	mA
R1	bias resistor	47	kΩ
R2	open	_	_

PINNING

PIN	DESCRIPTION	
1	base/input	
2	emitter/ground (+)	
3	collector/output	

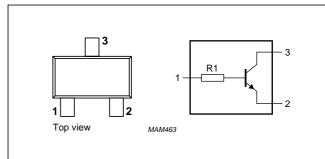
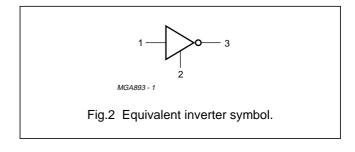


Fig.1 Simplified outline (SOT490) and symbol.



NPN resistor-equipped transistor; R1 = 47 k Ω , R2 = open

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	50	٧
V _{CEO}	collector-emitter voltage	open base	_	50	V
V_{EBO}	emitter-base voltage	open collector	_	10	V
Io	output current (DC)		_	100	mA
I _{CM}	peak collector current		_	100	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	_	250	mW
T _{stg}	storage temperature		-65	+150	°C
T _j	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

Note

1. For mounting conditions, see "Thermal considerations and footprint design for SOT490 in the SC18 Data Handbook".

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	in free air; note 1	500	K/W

Note

1. For mounting conditions, see "Thermal considerations and footprint design for SOT490 in the SC18 Data Handbook".

CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	V _{CB} = 50 V; I _E = 0	_	_	100	nA
I _{CEO}	collector-emitter cut-off current	V _{CE} = 30 V; I _B = 0	_	_	1	μΑ
		$V_{CE} = 30 \text{ V}; I_{B} = 0; T_{j} = 150 ^{\circ}\text{C}$	_	_	50	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_{C} = 0$	_	_	100	nA
h _{FE}	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 1 \text{ mA}$	100	_	_	
V _{CEsat}	collector-emitter saturation voltage	$I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}$	_	_	150	mV
R1	input resistor		33	47	61	kΩ
C _c	collector capacitance	I _E = i _e = 0; V _{CB} = 10 V; f = 1 MHz	_	_	2.5	pF

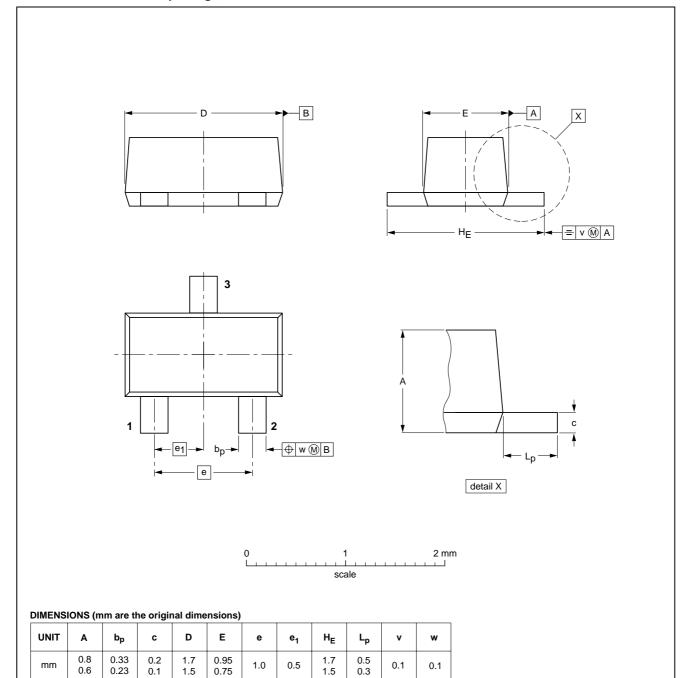
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PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT490



ou	JTLINE	REFERENCES			EUROPEAN ISSUE DATE		
VE	RSION	IEC	JEDEC	EIAJ		PROJECTION ISSUE I	
SC	OT490			SC-89			98-10-23

NPN resistor-equipped transistor; R1 = 47 k Ω , R2 = open

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DATA SHEET STATUS(1)	PRODUCT STATUS ⁽²⁾	DEFINITIONS
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Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
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NOTES

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NOTES

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